

December 5, 2001

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Form PTO-1449 U.S. Department of Commerce Patent and Trademark Office INFORMATION DISCLOSURE STATEMENT BY APPLICANT	Atty. Docket No.	Serial No.
	56352USA3A	09/911,950
	Applicant	
	BARRY S. CARPENTER et al.	
	Filing Date	Group
	July 24, 2001	

U.S. PATENT DOCUMENTS

Examiner Initial	Document Number	Date MM/DD/YY	Name	Class	Subclass	Filing Date If Appropriate
SK	4,119,363	10/10/1978	Camlibel et al.			
SK	4,186,995	02/05/1980	Schumacher			
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SK	5,555,330	09/10/1996	Pan et al.			
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SK	0 010 352	4-1980	EP			Yes
SK	0 414 338 A2	2-1991	EP			Yes
SK	0 465 230 B 1	5-1995	EP			Yes
SK	0 637 765 B1	12-1998	EP			Yes

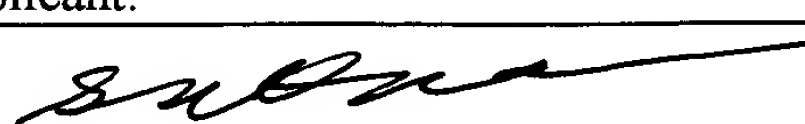
OTHER PRIOR ART-NON PATENT LITERATURE DOCUMENTS

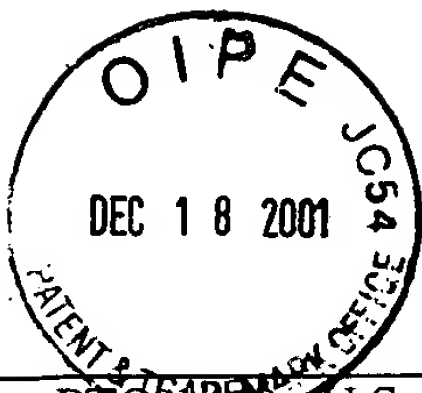
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M2:20428715.01

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Form PTO-402 U.S. Department of Commerce Patent and Trademark Office INFORMATION DISCLOSURE STATEMENT BY APPLICANT	Atty. Docket No.	Serial No.
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	July 24, 2001	

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SK	0 762 161 A1	3-1997	EP			No
SK	0 852 337 A1	7-1998	EP			Yes
SK	0 853 396 A2	7-1998	EP			Yes
SK	0 886 144 A1	12-1998	EP			Yes

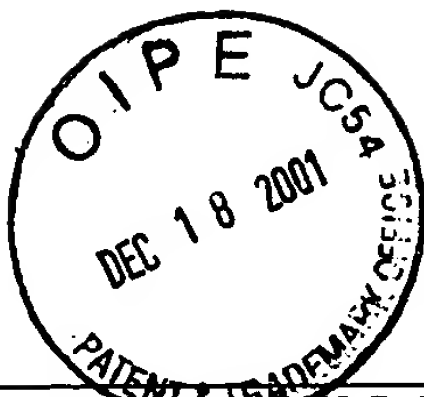
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	SK	Lin et al., "Lightwave Micromachines for Optical Crossconnects".	
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	SK	W. Ko., "Packaging of Microfabricated Devices and Systems", 42 Materials Chemistry and Physics 169-175 (1995).	
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	SK	Ramesham et al., "Challenges in Interconnection and Packaging of Microelectromechanical Systems", IEEE Electronic Components and Technology Conference (2000).	
	SK	Comtois et al., "Applications for Surface-Micromachined Polysilicon Thermal Actuators and Arrays", 58 Sensors and Actuators 19-25 (1997).	
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